Addendum #1 RFP Questions and Answers

- Is there a model preference for the UPS? (Ex: 1500KVA vs a larger UPS for the IDFs)
 A: We are not able to request a specific brand or model for any of the devices. We can provide the specifications needed and listed in the RFP.
- Is UPS monitoring a requirement?
 A: NO, but it is desired.
- What type of new cabling is needed for the Our Lady of Lourdes School site?
 A: Cat 6 (or higher) as this will connect one location to the rest of the network.
- Do you know the switch port type you would like?
 A: Refer to the RFP.
- For the expected APs, which are internal versus external quantities?
 A: This should be in the site appendix already. If not, then site walks are warranted.
- Do you have a license length preference for manufacturer support?
 A: 7 years
- For SFP's, would you like single mode, multi-mode, or the capability for both?
 A: Locations use mostly OM-3 multimode fiber spans. So, 10G-SR SFP+ modules.
- Does the asbestos requirement only pertain to cabling at the one site?
 A: The asbestos requirements apply to all sites, but the majority of the school locations are "rip and replace equipment" work.
- Do you want proposals, broken out by site or materials shown as combined? (E-rate no longer requires site)
 A: We need per-site proposals
- 10. The bidder sheet link appears inaccessible on https://c3.la-archdiocese.org/e-rate-2024. Can you check/send it as an attachment?
 A: Please recheck the site, but If the problem persists, send a request to Mr. Paul Hernandez at phernandez@la-archdiocese.org and he will send you a copy for your proposal bid.
- 11. With the expected IDF requirement, what is the preference for fans, filters, and overall size that should be used in the spec?
 A: Rack size for new racks should be determined by a site walk. No preference for fans or filters.
- 12. Is this a prevailing wage job?

A: We have not asked for prevailing wage labor bids nor are not required to do so. The bidder will follow required state and local Los Angeles, Ventura and Santa Barabara Counties as applies.

- 13. What are the distances for the wireless bridges? A: Under 750 meters.
- 14. Are all AP quantities going to be for indoors? If not, what's the quantity of the outdoor APs and how will they be mounted?A: See Q #5
- Are all fiber connections MMF? If not, what's the quantity of SMF transceivers needed?
 A: See Q #7
- 16. Is layer 3 capabilities needed on the switches?*A: No, but they do need to have full management capabilities.*
- 17. Are the site walks as listed on the website mandatory? *A: No.*
- May ADLA please provide an extension to this response? The proposed site walk schedule has its last walk on February 29, one day before this hard copy is due March 1.
 A: The E-rate committee has decided that we will accept RFP Bids on Monday, March 4th, 2024, at 9:00 PM PST.
- May ADLA please provide Zoom call attendance information?
 A: The only Zoom meeting information that has been provided was for the bidder meeting held on February 4, 2024.
- In Section 8.4 Labor Rate Spreadsheet, ADLA states bidders must complete a Labor Rate spreadsheet using the given format, but ADLA did not provide any attachment or tab within the C2ICBidSheet called "Labor Rate." What should vendors utilize to provide this information?
 A: In the C2ICBidSheet file, the sheet labeled "Rate Card Sample" and "Rate Card Blank Form" address the "Labor Rate".
- 21. In Section 8.3 Cost Spreadsheet, ADLA calls their Cost Spreadsheet an Item 21 attachment form. The federal E-Rate program has an Item 21 form for each E-Rate project that is not this form. Does ADLA want vendors to only fill out the issued C2ICBidSheet, only fill out an Item 21 form from the E-Rate program, both, or neither?

A: On page 10, there is a number formatting issue whereas there are two 2.1.1 - 2.1.3. In the second 2.1.2 (with no further bullet points), states: "The bidder shall provide item 21 Attachment information in an electronic form that can be transferred into the EPC as required by USAC..." As the Item 21 attachment is now online, using the provided form will be needed at this time.

22. In Section 1.7.2, ADLA asks about vendor credit rating information, required lender reporting, and significant unrecorded contingent liabilities. Would ADLA be willing to sign a mutual non-

disclosure agreement in order to get that information from vendors? If so, what process should be followed?

A: Yes, we will work with the vendor/bidder on how a process to sign an NDA, if needed.

- 23. For the sites that have been walked in person, are we to include one SFP Per switch to allow for future fiber growth (Counts, discovered by walk attendees at the six sites)?
 A: In the majority of the Consortium schools, the current configuration is copper-to-copper and we would keep that as the protocol. Bidders can include the cost for one SFP in their bid list of equipment for reference as outlined in Appendix C should a school currently have and need a SFP.
- 24. For St. Paul the Apostle School, no site map was available for the site walk. When will ADLA be providing this site map?
 A: The link to the <u>Site map is here</u>. (Please note this project was not completed by the school using this map.)
- 25. For St. Paul the Apostle School, in buildings 30 and 50 all classrooms have a existing 10-port switch connected to APs in the classrooms. Are those being replaced as part of this project? If so, the school needs to provide the exact number of locations / classrooms that require the replacement of 10-port switches.

A: The current set-up should be considered for the bid as is it how the school is currently configured. The school is working to provide a current layout of the school.

26. During the site walk at St. Anne Mission School, it was discussed that four switches are connected via CAT6 backbone. School officials want to reconnect those with the 10 gig SFP along with a 10 GIG fiber patch board. Since vendors are walking six sites, how does ADLA want vendors to calculate the remaining 35 sites?

A: See A: #23. All bids should reflect the current configuration of copper-to-copper.